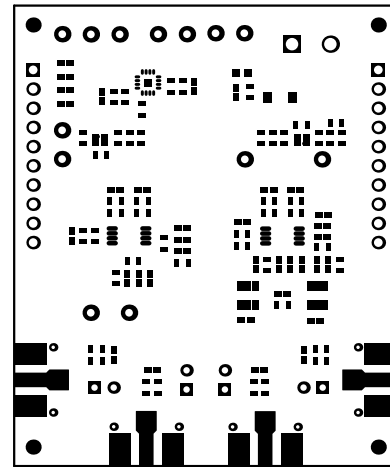
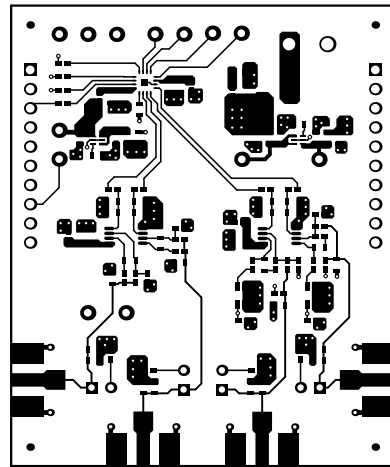


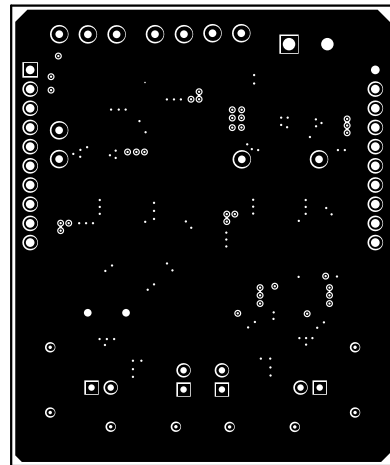
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01583	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-01583		
PLOT NAME = Top Overlay	GENERATED : 11/7/2017	10:53:52 PM	TEXAS INSTRUMENTS



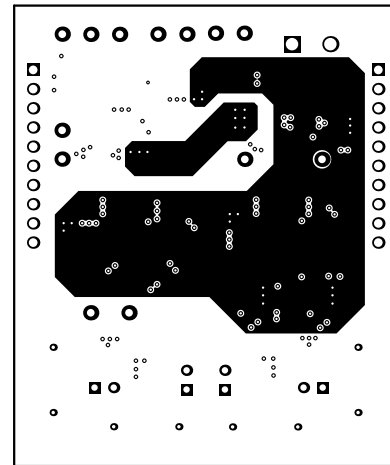
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01583	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01583		
PLOT NAME = Top Solder Mask	GENERATED : 11/7/2017 10:53:53 PM	TEXAS INSTRUMENTS	



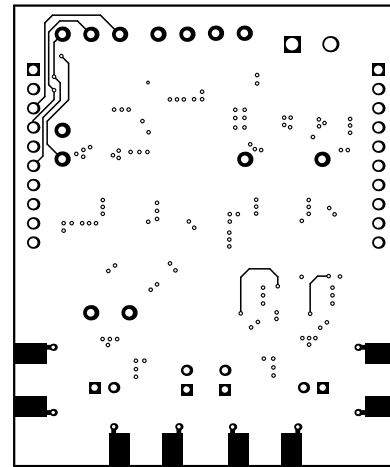
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01583	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01583		
PLOT NAME = Top Layer	GENERATED : 11/7/2017 10:53:53 PM	TEXAS INSTRUMENTS	



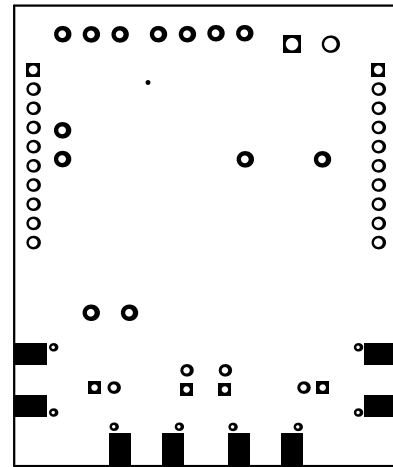
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01583	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = GND	TID #: TIDA-01583		
PLOT NAME = Signal Layer 1	GENERATED : 11/7/2017 10:53:54 PM	TEXAS INSTRUMENTS	



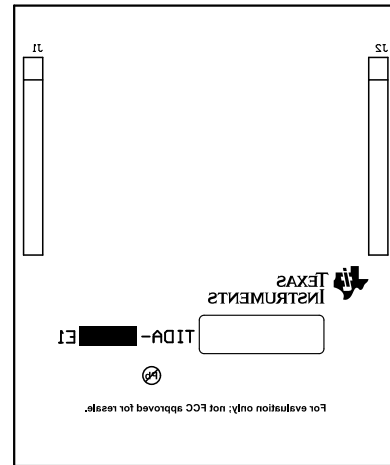
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01583	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = PWR	TID #: TIDA-01583		
PLOT NAME = Signal Layer 2	GENERATED : 11/7/2017 10:53:55 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01583	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-01583		
PLOT NAME = Bottom Layer	GENERATED : 11/7/2017 10:53:56 PM	TEXAS INSTRUMENTS	



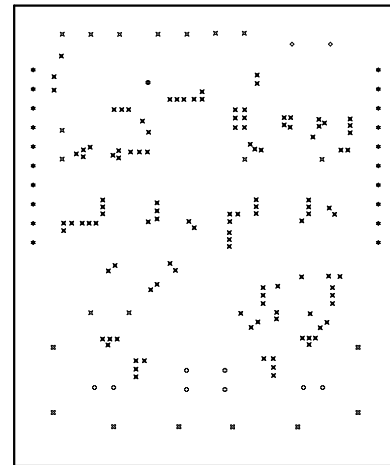
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01583	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01583		
PLOT NAME = Bottom Solder Mask	GENERATED : 11/7/2017 10:53:57 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01583	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01583		
PLOT NAME = Bottom Overlay	GENERATED : 11/7/2017 10:53:58 PM	TEXAS INSTRUMENTS	



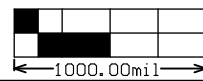
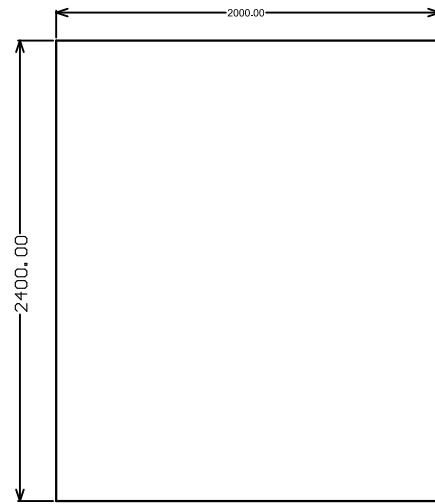
DIMENSIONS ARE IN MILS



Symbol	Hit Count	Finished Hole Size	Plated	Hole Type
⊙	1	7.87mil (0.200mm)	PTH	Round
◇	2	64.96mil (1.650mm)	PTH	Round
⊠	8	18.00mil (0.457mm)	PTH	Round
⊙	8	33.47mil (0.850mm)	PTH	Round
⊠	13	40.00mil (1.016mm)	PTH	Round
⊛	20	45.28mil (1.150mm)	PTH	Round
⊠	118	12.00mil (0.305mm)	PTH	Round
	170 Total			

DRILL TABLE  
 FOR 7.87MIL DRILL +0/-7.87MIL  
 FOR 12MIL DRILL +0/-12MIL  
 FOR PTH DRILL +/-3MIL  
 NOTE:  
 12MIL Vias are Tented in both the sides.  
 7.87MIL vias are not Tented.  
 This is not an Impedance controlled board.

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01583	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01583		
PLOT NAME = Drill Drawing	GENERATED : 11/7/2017	10:53:58 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01583	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01583		
PLOT NAME = Board Dimensions	GENERATED : 11/7/2017 10:54:00 PM	TEXAS INSTRUMENTS	

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